

Vishay Semiconductors

Standard Avalanche Sinterglass Diode



949539

MECHANICAL DATA

Case: SOD-57

Terminals: plated axial leads, solderable per MIL-STD-750,

method 2026

Polarity: color band denotes cathode end

Mounting position: any **Weight:** approx. 369 mg

FEATURES

- Glass passivated junction
- Hermetically sealed package
- Low reverse current
- High surge current loading
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

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COMPLIANT HALOGEN

APPLICATIONS

• Rectification, general purpose

PARTS TABLE			
PART	TYPE DIFFERENTIATION	PACKAGE	
BYX82	V _R = 200 V; I _{FAV} = 2 A	SOD-57	
BYX83	$V_R = 400 \text{ V}; I_{FAV} = 2 \text{ A}$	SOD-57	
BYX84	$V_R = 600 \text{ V}; I_{FAV} = 2 \text{ A}$	SOD-57	
BYX85	V _R = 800 V; I _{FAV} = 2 A	SOD-57	
BYX86	V _R = 1000 V; I _{FAV} = 2 A	SOD-57	

PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
Reverse voltage = repetitive peak reverse voltage		BYX82	$V_R = V_{RRM}$	200	V
		BYX83	$V_R = V_{RRM}$	400	V
	See electrical characteristics	BYX84	$V_R = V_{RRM}$	600	V
		BYX85	$V_R = V_{RRM}$	800	V
		BYX86	$V_R = V_{RRM}$	1000	V
Peak forward surge current	t _p = 10 ms, half sine wave		I _{FSM}	50	Α
Repetitive peak forward current			I _{FRM}	10	Α
Average forward current	T _{amb} ≤ 45 °C		I _{FAV}	2	Α
i ² * t-rating			i ² * t	8	A ² * s
Junction and storage temperature range			$T_j = T_{stg}$	- 55 to + 175	°C

MAXIMUM THERMAL RESISTANCE (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Junction ambient	Lead length I = 10 mm, T _L = constant	R_{thJA}	45	K/W
	On PC board with spacing 25 mm	R_{thJA}	100	K/W

BYX82, BYX83, BYX84, BYX85, BYX86

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ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX	UNIT
Forward voltage	I _F = 1 A	V _F	-	0.9	1	V
Reverse current	$V_R = V_{RRM}$	I _R	-	0.1	1	μA
	$V_R = V_{RRM}, T_j = 100 ^{\circ}C$	I _R	-	10	25	μA
Diode capacitance	V _R = 4 V, f = 1 MHz	C _D	-	20	-	pF
Reverse recovery time	I _F = 0.5 A, I _R = 1 A, i _R = 0.25 A	t _{rr}	-	2	4	μs
Reverse recovery charge	$I_F = I_R = 1 \text{ A, dI/dt} = 5 \text{ A/}\mu\text{s}$	Q _{rr}	-	3	6	μC

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

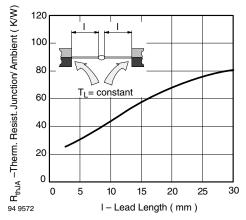


Fig. 1 - Max. Thermal Resistance vs. Lead Length

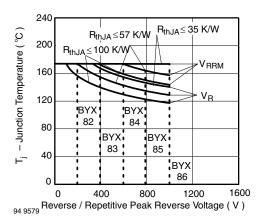


Fig. 2 - Junction Temperature vs. Reverse/Repetitive Peak Reverse Voltage

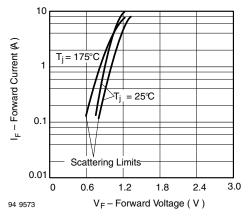


Fig. 3 - Forward Current vs. Forward Voltage

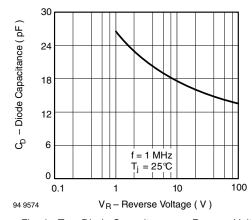


Fig. 4 - Typ. Diode Capacitance vs. Reverse Voltage



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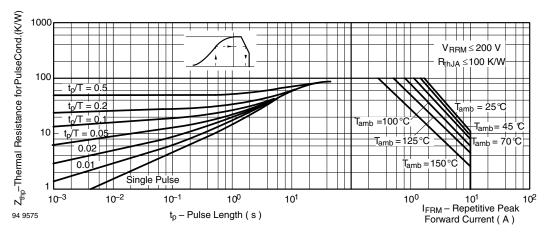


Fig. 5 - Thermal Response

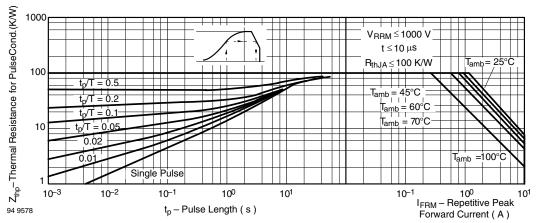


Fig. 6 - Thermal Response

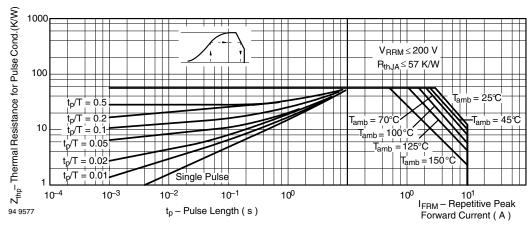


Fig. 7 - Thermal Response

BYX82, BYX83, BYX84, BYX85, BYX86

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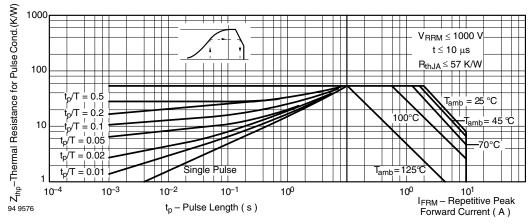
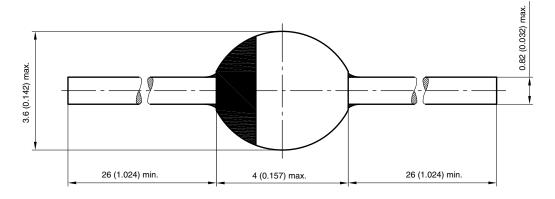


Fig. 8 - Thermal Response

PACKAGE DIMENSIONS in millimeters (inches): SOD-57



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